



RECOMMENDED FOOTPRINT LAYOUT

FS) www.fciconnect.com					tolerance	projection	ММ
Dr Eng Chr	MAGGIE WU R Y LIU PAUL WANG JOSEPH HSIA	07/23/04 07/23/04 07/23/04 07/23/04	Product family 3G10 Spec ref Material			size A4	Scale 1.000 DG06-0249
+ + - - - - -					ou 6mp	10039755 Rev.	
cata	log no	DM. Pov	Joacon	TOMER .	sheet 4 of 6		

5-50u" Ni UNDERPLATE

GOLD FLASH CONTACT AREA

100u" TIN/LEAD TAIL AREA ------RoHS COMPLIANT EXCEPT Pb

NOTES: I. MATERIAL: CONNECTOR # POS REF DIM "A" DIM "B" DIM "C" DIM "F" N HOUSING: HIGH TEMPERATURE NYLON, GLASS FILLED UL94V-0 RATED. SUITABLE FOR REFLOW SOLDERING. I PORT 36 6 7.65 9.15 6.00 25.00 TERMINAL: COPPER ALLOY PLATING: 50u" NICKEL UNDERPLATE ALL OVER 4 PORT 20 21.65 39.00 23.15 20.00 64 CONTACT AREA PLATING - SEE PRODUCT NUMBER CODE 8 PORT 37 98 38.65 56.00 40.15 37.00 SOLDER TAIL: TIN - 100u" MIN. OVER 50u" NICKEL OR TIN/LEAD 100u" MIN. SEE PRODUCT NUMBER CODE 16 PORT 164 70 71.65 89.00 73.15 70.00 PRODUCT SPECIFICATION: GS-12-319 THE HORIZONTAL AXIS FOR THE HOLE PATTERN IS ESTABLISHED BY A LINE THROUGH THE CENTER OF THE TWO Ø 2.35 HOLES THE VERTICAL AXIS IS 90° TO THE HORIZONTAL AXIS. THROUGH THE CONTER OF DATIM 7 A NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS AT AND PIN NUMBERS "F" CHAMFER EDGES MUST BE FREE OF CUTTING BURRS. ALL PTH SHOULD BE 0.76~0.83 mm DIA DRILLED AND 0.025~0.05 mm. ELECTRO-DEPOSITED COPPER THK ON THROUGH HOLE WALL. 7. ROHS COMPATIBLE PRODUCT SPECIFICATIONS -Date code: a-PLATING: "YY" means year number -"LF" MEANS THE PRODUCT IS LEAD-FREE. 2um MINIMUM MATTE TIN OVER 1.27um "MM" means month number "DD" means day number MINIMUM NICKEL UNDERPLATE "X" means manufacture location b-MANUFACTURING PROCESS CPMPATIBILITY "D" means made in Dongguan site "Y" means shift number -THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C SOLDER BATH TEMPERATURE FOR If date code is 060626DI, it means this part 5 SECONDS IN A REFLOW SOLDER APPLICATION WITH A L.6mm MIN THICK CIRCUIT BOARD. is made by shift I in 2006/06/26 and manufactured in Dongquán site PRODUCT NUMBER CODE Date code should be laser mark 10039755 - X X X X X X X X LEAD FREE OPTION HOUSING COLOR OPTIONS -"LF" FOR TERMINAL PLATING OPTION 0,1,2 I-BLACK LEAVE BLANK FOR TERMINAL PLATING 3.4.5 PEGS OPTIONS -PACKAGING OPTIONS 0-PLASTIC PEGS T-TRAY PACKAGING POS OPTIONS TERMINAL PLATING OPTIONS -0 - 36 0-50u" Ni UNDERPLATE 1-64 30u" Au CONTACT AREA 2-98 100u" TIN TAIL AREA ------COMPATIBLE ROHS 3-164 I-50u" Ni UNDERPLATE 15u" Au CONTACT AREA tomerance unless 100u" TIN TAIL AREA ------COMPATIBLE ROHS otherwise specified DIM "D" SUGGESTED PCB THICKNESS 2-50u" Ni UNDERPLATE $. X \pm .3$ 194 IL PENROTHOOBY LONS GOLD FLASH CONTACT AREA 2.36 XX ± .2 linear 100u" TIN TAIL AREA ------COMPATIBLE ROHS XXX ± . I 3.25 ± 0.20 4 19 3-50u" Ni UNDERPLATE $0^{\circ} \pm 2$ anales 30u" Au CONTACT AREA tolerance projection 100u" TIN/LEAD TAIL AREA ------RoHS COMPLIANT EXCEPT Pb MMwww.fciconnect.com 4-50u" Ni UNDERPLATE 15u" Au CONTACT ARFA MAGGIE WU 07/23/04 100u" TIN/LEAD TAIL AREA ------RoHS COMPLIANT EXCEPT Pb Product family

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